DATASHEET - EWP-05112



EWP wall-mount enclosure for EP standard mounting units, IP54, protection class 2, RAL9016, without EP modules, HxWxB=1100x550x225mm



Part no. EWP-05112 Catalog No. 174683 Alternate Catalog EWP-05112

No.

EL-Nummer 2455871

(Norway)

Design verification as per IEC/EN 61439

Heat dissipation, at an ambient temperature of 35°C, delta T: 20 degrees in top of the enclosure, calculated as per IEC 60890 Individual enclosure for wall mounting Pv W 75 Middle enclosure for wall mounting Pv W 58 Heat dissipation, at an ambient temperature of 35°C, delta T: 35 degrees in top of the enclosure, calculated as per IEC 60890 Individual enclosure for wall mounting Pv W 123 Starting enclosure for wall mounting Pv W 151 Middle enclosure for wall mounting Pv W 151 Middle enclosure for wall mounting Pv W 161	besign vermeation as per 120/214 01405			
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10.12 Electromagnetic compatibility Is the panel builder's responsibility.	10.10 Temperature rise			
	10.11 Short-circuit rating			Is the panel builder's responsibility.
10.13 Mechanical function Meets the product standard's requirements.	10.12 Electromagnetic compatibility			Is the panel builder's responsibility.
	10.13 Mechanical function			Meets the product standard's requirements.

Technical data ETIM 7.0

Cabinet enclosures (EG000011) / Enclosure/switchgear cabinet (empty) (EC000261)					
Electric engineering, automation, process control engineering / Electrical cabinet, housing, rack / Electrical cabinet (empty) / Electrical cabinet (ecl@ss10.0.1-27-18-01-01 [AGZ056016])					
Width	mm	550			
Height	mm	1100			
Depth	mm	225			

Material	Steel
Material quality	
Surface finishing	Powder coating
Colour	White
RAL-number	9016
With mounting plate	No
Mounting plate depth-adjustable	No
Number of locks	1
Floor installation possible	No
Wall fastening possible	Yes
Wall build in	Yes
Pole fastening	No
Tackable	Yes
Number of doors	1
Suitable for metrical mounting	Yes
Suitable for outdoor set-up	No
Pitched roof	No
EMC-version	No
With glazed door	No
With ventilation door	No
With backside door	No
Impact strength	IK09
Degree of protection (IP)	IP54
Degree of protection (NEMA)	



